11-07-02

PATENT 910000-2028.1 ##.5

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

Borenstein et al.

Serial No.

10/038,891

Filed

January 2, 2002

For

TISSUE ENGINEERING OF THREE-DIMENSIONAL

VASCULARIZED USING MICROFABRICATED POLYMER

ASSEMBLY TECHNOLOGY

Examiner

To Be Assigned

Art Unit

To Be Assigned

745 Fifth Avenue New York, NY 10151

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## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Dear Sir:

The Examiner's attention is respectfully drawn to the enclosed documents listed on the accompanying PTO form 1449.

As this Information Disclosure Statement is being filed before the mailing of the first Office Action, it is believed that no fee is required for entry of this paper. However, the Commissioner is hereby authorized to charge any such fee, or credit any overpayment to Deposit Account 50-0230.

The filing of this Information Disclosure Statement is not an admission that the documents identified herein constitute prior art to the present application.

Applicants respectfully request that the Examiner considers and makes of record the documents cited herewith and that a copy of Form PTO-1449 be initialed by the Examiner and returned to the undersigned.

Respectfully submitted,

FROMMER LAWRENCE & HAUG LLP Attorneys for Applicants

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